



Product Change Notification

Change Notification #: 117778 - 00
Change Title: Select Intel® SSD DC P4511 Series Products,
PCN 117778-00, Product Material,
Ferrite bead second source
Date of Publication: September 21, 2020

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	October 22, 2020
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Description of Change to the Customer:

The Intel® SSD P4511 Series SKUs listed in the Products Affected table below will undergo the following update:

- The ferrite bead H35636-008 will be sourced from a second supplier.

Customer Impact of Change and Recommended Action:

This change has been thoroughly evaluated to ensure that there are no quality, reliability or functional implications to our customers. Intel is not recommending additional qualification of these changes on platforms received from Intel.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

For your information only. No change to form fit or function. No change to Intel Ordering codes.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#
Intel® SSD DC P4511 Series (1.0TB, M.2 110mm PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDPELKX010T801	965843
Intel® SSD DC P4511 Series (2.0TB, M.2 110mm PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDPELKX020T801	965844

PCN Revision History:

Date of Revision:
September 21, 2020

Revision Number:
00

Reason:
Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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